
IEEE® 802.3af/at PD Front End IC

Product Overview

The PD70100 and PD70200 devices are part of Microchip's series of Power over Ethernet (PoE) Powered Devices chips (PD). The PD70100 and PD70200 devices transmit integrated power and analog data in a single 12-pin package. They are used in Powered Devices (PD), thus enabling next generation network devices to share power and data over the same cable.

Microchip's PD family offers a solution to any PD application compliant with IEEE® 802.3af and IEEE 802.3at standards and 4-pairs extra power applications. The IC family's components can be used in both indoor and outdoor applications.

The device family meets all PD-side-standards such as:

- Detection
- Classification
- Integrated isolation switch with inrush current limiter, and over-current protection
- Two-events classification recognition and AT flag generation (PD70200 only).

In addition, the devices have a discharge mechanism for a DC/DC input capacitor, ensuring quick redetection capability in case the RJ-45 plug is disconnected and reconnected within a short time span.

PD70200 IC design specifically supports IEEE 802.3at standard, including two events classification detection that enables the PD to distinguish whether the connected power source equipment (PSE) is IEEE 802.3at or IEEE 802.3af based.

The PD70100/PD70200 ICs are designed to support 4 pair applications for PDs that require higher power.

Features

- Designed to Support IEEE 802.3af and IEEE 802.3at standards
- PD Detection & Programmable Classification Signature
- Two-events Classification Flag
- Signature Resistor Disconnection after Detection
- Integrated 0.6 Ω Isolating Switch and Inrush Current Limiter.
- 4-pairs support with a single PD70200 IC for up to 48 W
- 4-pairs support with two PD70200 ICs for up to 96 W
- Less than 10 μ A Offset Current during Detection
- Single DC Voltage Input (37 V – 57 V)
- Wide Operating Temperature Range: -40 to 85 °C
- On-chip Thermal Protection
- 12-pin 3 × 4mm Package
- RoHS Compliant
- MSL3

Table 1. Microchip Powered Device Products Offerings

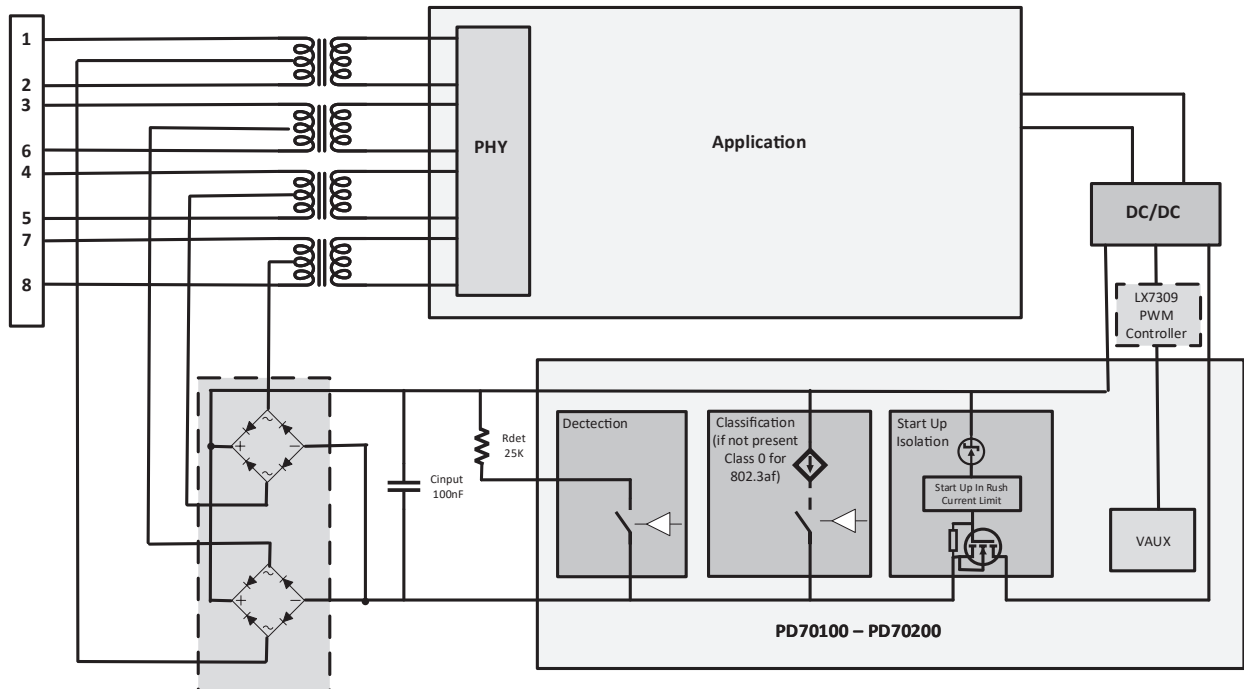
Part	Type	Package	IEEE 802.3af	IEEE 802.3at	HDBaseT (PoH)	UPoE
PD70100	Front End	3 mm × 4 mm 12L DFN	x	—	—	—
PD70101	Front End + PWM	5 mm × 5 mm 32L QFN	x	—	—	—
PD70200	Front End	3 mm × 4 mm 12L DFN	x	x	—	—
PD70201	Front End + PWM	5 mm × 5 mm 32L QFN	x	x	—	—
PD70210	Front End	5 mm × 5 mm 16L DFN	x	x	x	x
PD70210A	Front End	4 mm × 5 mm 16L DFN	x	x	x	x
PD70210AL	Front End	5 mm × 7 mm 38L QFN	x	x	x	x
PD70211	Front End + PWM	6 mm × 6 mm 36L QFN	x	x	x	x
PD70224	Ideal Diode Bridge	6 mm × 8 mm 40L QFN	x	x	x	x

Applications

- Power over Ethernet Powered Devices
- IEEE 802.3af/at 10/100/1000 BASE-T
- 4-pair extra power applications
- Indoor and outdoor applications

The following illustration shows a basic block diagram using PD70100 or PD70200.

Figure 1. Basic PD Block Diagram



Microchip offers complete reference design packages and Evaluation Boards (EVBs). For access to these design packages, device datasheets, or application notes, consult your local Microchip Client Engagement Manager or visit our website at www.microchip.com/poe. For technical support, consult your local Embedded Solutions Engineers or go to microchipsupport.force.com/s/. For help in designing the DC/DC portion of your circuit, please try our MPLAB Analog Designer (MAD) tool at www.microchip.com/mad-poe.

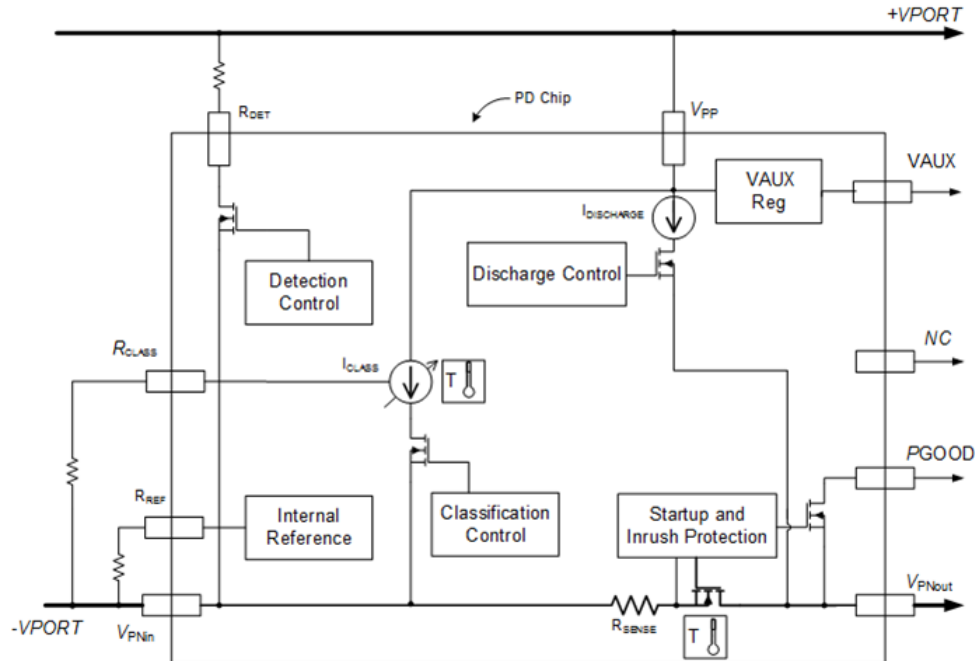
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1. Functional Descriptions

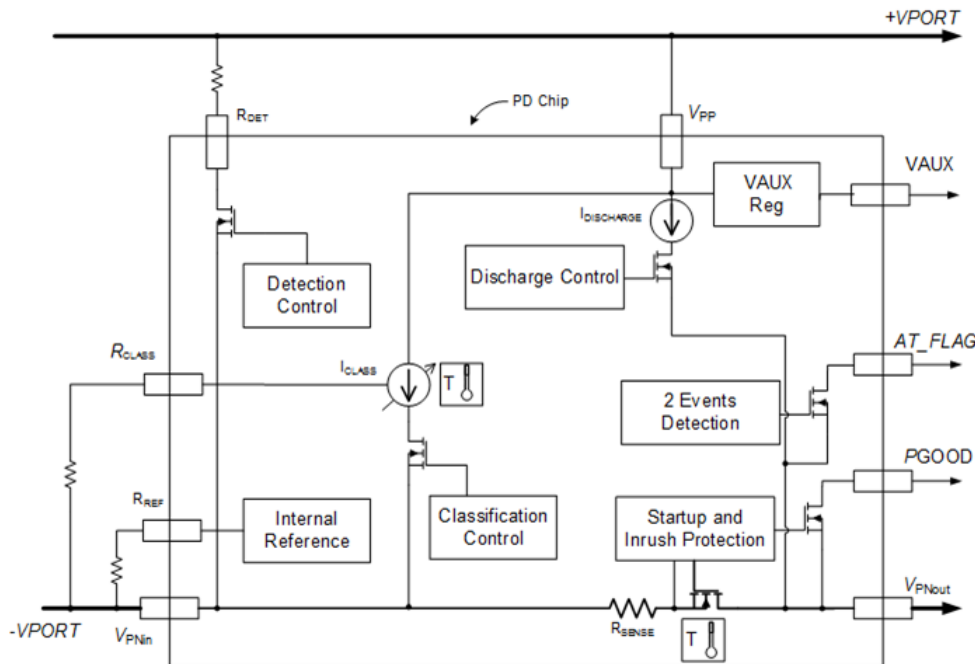
The following illustration shows the functional blocks of the PD70100.

Figure 1-1. PD70100 Functional Block Diagram



The following illustration shows the functional blocks of the PD70200.

Figure 1-2. PD70200 Functional Block Diagram



1.1 Detail Description

PD70100/PD70200 IC provides IEEE 802.3af/at compliant PD Front-End functions including Detection, Physical Layer Classification, Two-Events Classification (PD70200 only), Auxiliary Voltage Output, Power Good, Soft Start Current Limiting, Over-Current Protection, and Bulk Capacitor Discharge.

1.1.1 Detection

IEEE 802.3af/at compliant detection is provided by a 24.9 K Ω resistor connected between V_{PP} and R_{DET} pin. R_{DET} pin is connected to VPN_{IN} via an open drain MOSFET with a maximum specified $R_{DS_{ON}}$ of 50 Ω . Internal logic monitors V_{PP} to VPN_{IN} and connects the R_{DET} pin to VPN_{IN} when the rising V_{PP} to VPN_{IN} voltage is between 2.5 V and 10.1 V. When rising V_{PP} to VPN_{IN} voltage exceeds 10.1 V, the MOSFET is switched off. Once above 10.1 V, falling V_{PP} to VPN_{IN} voltage between 2.45 V and 4.85 V will reconnect R_{DET} pin to VPN_{IN} .

1.1.2 Physical Layer Classification

Physical Layer (hardware) Classification per IEEE 802.3af/at is generated via a regulated reference voltage of 1.2 V, switched onto the R_{CLASS} pin. Internal logic monitors the V_{PP} to VPN_{IN} voltage and connects the 1.2 V reference to R_{CLASS} pin at a rising V_{PP} to VPN_{IN} voltage threshold between 11.1 V and 13.5 V. Once V_{PP} to VPN_{IN} has exceeded the rising threshold, there is a 1 V minimum hysteresis between the V_{PP} rising (turn-on) threshold and the V_{PP} falling (turn-off) threshold.

The 1.2 V reference stays connected to the R_{CLASS} pin until the V_{PP} to VPN_{IN} rising voltage exceeds the upper turn-off threshold of 20.9 V to 23.9 V. The 1.2 V reference voltage is disconnected from the R_{CLASS} pin at V_{PP} to VPN_{IN} voltages above the upper threshold.

Classification current signature is provided via a resistor connected between R_{CLASS} pin and VPN_{IN} . The classification current is therefore the current drawn by the PD70100/PD70200 IC during the classification phase, and is simply the 1.2 V reference voltage divided by the R_{CLASS} resistor value. The maximum current available at the R_{CLASS} pin is current limited to 55 mA (typical).

1.1.3 Two-Events Detection and AT Flag

The PD70200 IC provides IEEE 802.3at Type 2 compliant detection of the “Two Events Classification Signature”, and generation of the AT flag. This feature is available on the PD70200 IC only.

Simply put, the “Two Events Classification Signature” is a means by which an IEEE 802.3at Type 2 Power Source can inform a compliant Power Device (PD) that it is AT Type 2 compliant, and as such is capable of providing AT Type 2 power levels.

The Power Source communicates with a Type 2 compliant signature by toggling the V_{PP} to VPN_{IN} voltage twice (2 “events”) during the Physical Layer Classification phase. The V_{PP} to VPN_{IN} voltage is toggled from the Physical Layer Classification’s voltage level (13.5 V to 20.9 V) down to a voltage “Mark” level. Voltage “Mark” level is specified as a V_{PP} to VPN_{IN} voltage of 4.9 V to 10.1 V.

PD70200 IC recognizes a V_{PP} to VPN_{IN} falling edge from Classification level to Mark level as being one event of the Two-Events Signature. If two such falling edges are detected, PD70200 will assert AT flag by means of an open drain MOSFET connected between AT_FLAG pin and VPN_{OUT} .

AT_FLAG pin is active low; a low impedance state between AT_FLAG and VPN_{OUT} indicates a valid Two-Events Classification Signature was received, and the Power Source is AT Type 2 compliant.

AT_FLAG MOSFET is capable of 5 mA of current and can be pulled up to V_{PP} .

1.1.4 Soft Start and Inrush Current Protection

PD70100/PD70200 IC contains an internal isolation switch, that provides ground isolation between Power Source and PD application during Detection and Classification phases. The isolation switch is a N-channel MOSFET, wired in a common source configuration where the MOSFET’s Source is connected to Power Source ground at VPN_{IN} , and the MOSFET’s Drain is connected to application’s primary ground at VPN_{OUT} .

Internal logic monitors V_{PP} to VPN_{IN} voltage and keeps the MOSFET in a high impedance state until V_{PP} to VPN_{IN} voltage reaches turn-on threshold of 36 V to 42 V. Once V_{PP} to VPN_{IN} voltage exceeds this threshold, the MOSFET is switched into one of two modes.

The mode into which the MOSFET is switched is determined by the voltage developed across the MOSFET, or put another way, the VPN_{OUT} to VPN_{IN} differential voltage. Two modes are defined below:

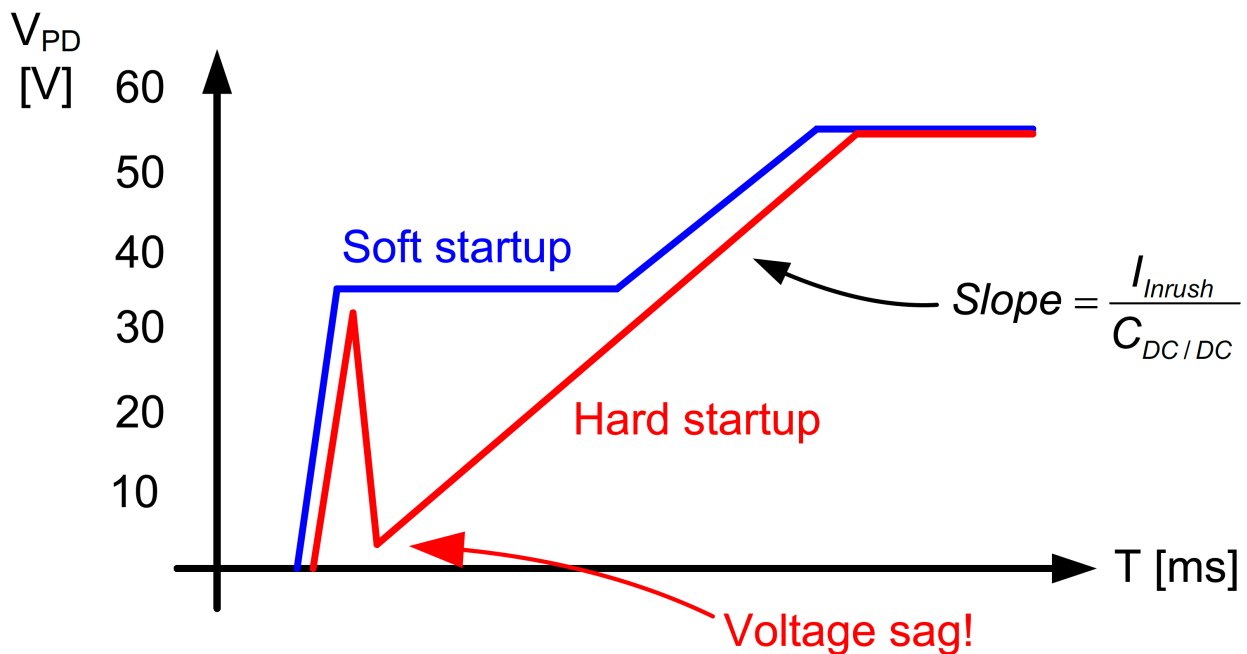
Table 1-1. Isolation Switch Modes

VPN_{OUT} to VPN_{IN}	Mode	Description
$>0.7\text{ V}$	Soft Start Mode	Limits VPN_{OUT} current to 240 mA (typical)
$\leq 0.7\text{ V}$	Normal Operating Mode	Limits VPN_{OUT} current to 1.8 A (typical)

By controlling the MOSFET current based on VPN_{OUT} to VPN_{IN} voltage, inrush currents generated by fully discharged bulk capacitors can be limited. This method limits current to a maximum of 350 mA, compliant with IEEE 802.3af/at specification.

Soft Start current limiting is required to reduce occurrences of voltage sag at the PD input during device power-up. A comparison is shown in the following figure.

Figure 1-3. Startup Comparison



Once bulk capacitance has charged up to a point where VPN_{OUT} to VPN_{IN} differential voltage is less than 0.7 V, the isolation MOSFET is switched into normal operating mode with MOSFET current limit set at 1.8 A (typical), to provide over-current protection.

PD70100 and PD70200 ICs are different in their respective isolation MOSFET's continuous current handling capability:

- PD70100: 450 mA (max.)
- PD70200: 1123 mA (max.)

An adequate heat sink for the PD70100/PD70200 IC's exposed pad must be provided to achieve these current levels without damaging the IC. A large, heavy copper fill area and/or a heavy ground plane with Thermal Vias is recommended. Electrically the exposed pad ground plane should be connected to VPN_{IN} .

Internal logic monitoring V_{PP} to VPN_{IN} will place the isolation switch MOSFET in a high impedance state if voltage between V_{PP} and VPN_{IN} drops below 31 V to 34 V.

1.1.5 Over-Current Protection

Over-current protection is provided on the PD70100/PD70200 IC using the Isolation MOSFET Switch, which limits the VPN_{OUT} current to 1.8 A during normal operation. See previous description of Soft Start.

1.1.6 Power Good

During Soft Start mode, the PD70100/PD70200 IC monitors $V_{PN_{OUT}}$ to $V_{PN_{IN}}$ differential voltage. When this voltage is less than 0.7 V (max.), the IC enters normal operation mode and the isolation switch current limit is increased to 1.8 A (typical). At this same 0.7 V (max.) threshold the Power Good signal is asserted by means of an open drain MOSFET between PGOOD and $V_{PN_{OUT}}$.

PGOOD pin is active low; a low impedance state between PGOOD and $V_{PN_{OUT}}$ indicates the Soft Start mode has finished and the isolation switch has transitioned into normal operating mode.

PGOOD MOSFET can handle current of 5 mA and can be pulled up to V_{PP} .

1.1.7 Auxiliary Voltage Output

PD70100/PD70200 IC provides a 10.5 V (typical) regulated output to be used as a start-up supply for DC/DC controllers whose V_{CC} is provided via a bootstrap winding. This regulated supply is available at V_{AUX} pin, and is referenced to $V_{PN_{OUT}}$ pin. V_{AUX} supply is designed for low-duty operation, and should not be designed as a primary housekeeping supply. The current capability is continuous 2 mA, with 10 mA peak (≤ 10 ms). V_{AUX} output is current-limited at 10 mA (min.).

For stability, the V_{AUX} regulator requires a minimum of 4.7 μ F ceramic capacitor connected directly between V_{AUX} and $V_{PN_{OUT}}$ pins.

1.1.8 Thermal Protection

Both PD70100 and PD70200 IC include temperature sensors which individually monitor both the isolation MOSFET and the Classification Current Source for over temperature conditions. In case of an over temperature condition, the sensor will activate protection circuitry which will disconnect its respective monitored function.

1.1.9 Bulk Capacitor Discharge

The bulk capacitor discharge circuitry eliminates the need to place a diode in series with the V_{PP} line to prevent an application's bulk capacitance from discharging through the detection resistor and the isolation switch MOSFET's body diode. Discharge current through the detection resistor can cause failure of the detection signature in cases where a PD is connected and the bulk capacitance is not fully discharged.

During normal operation, PD70100/PD70200 IC continuously monitors voltage at V_{PP} to $V_{PN_{IN}}$. Should V_{PP} to $V_{PN_{IN}}$ voltage fall below isolation switch turn-off threshold (31 V to 34 V), isolation switch MOSFET is immediately placed in a high-impedance state. At this point the internal logic monitors the voltage at V_{PP} to $V_{PN_{OUT}}$. If V_{PP} to $V_{PN_{OUT}}$ voltage is between 1.5 V to 32 V, a 23 mA (min.) constant current source is connected across the V_{PP} and $V_{PN_{OUT}}$ pins. This constant current source provides bulk capacitor discharge.

A 220 μ F bulk capacitance can be discharged from 32 V to 1.5 V in a maximal period of 292 ms.

2. Electrical Specifications

2.1 Absolute Maximum Ratings

Table 2-1. Absolute Maximum Ratings

Parameter	Description
Supply Input Voltage (V_{PP}) Continuous	-0.3 V to 74 V_{DC}
Supply Input Voltage (V_{PP}) 1 ms pulse	-0.3 V to 88 V_{DC}
Port Negative Out Voltage (VPN_{OUT})	-0.3 V to 74 V_{DC}
R_{DET} Continuous	-0.3 V to 74 V_{DC}
R_{DET} 1 mS pulse	-0.3 V to 88 V_{DC}
R_{CLASS} , R_{REF}	-0.3 V to 5 V_{DC}
V_{AUX}	-0.3 V to 30 V_{DC}
PGOOD, AT_FLAG (with respect to VPN_{OUT}) Continuous	-0.3 V to 74 V_{DC}
PGOOD, AT_FLAG (with respect to VPN_{OUT}) 1 mS pulse	-0.3 V to 88 V_{DC}
ESD Protection*	±1.5 kV HBM
Maximum Operating Junction Temperature (T_A)	150 °C
Operating Ambient Temperature	-40 °C to 85 °C
Storage Temperature Range	-65 °C to 150 °C
Peak Package Solder Reflow Temp (40 seconds max exposure)	260 °C

* All pins except pin 11 (V_{AUX}). Pin 11 ESD Protection ±150 V HBM.

** No pin voltage can be higher than V_{pp} .

Note: Exceeding these ratings could cause damage to the device. All voltages are with respect to VPN_{IN} except for V_{aux} , PGOOD and AT_FLAG with respect to VPN_{OUT} . Currents are positive into, negative out of specified terminal. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under “Recommended Operating Conditions” are not implied. Exposure to “Absolute Maximum Ratings” for extended periods may affect device reliability.

2.2 Typical Electrical Performance

Unless otherwise specified, the following specifications apply over the operating ambient temperature -40 °C ≤ T_{AMB} ≤ 85 °C. Production tests are done at 25 °C T_A .

2.2.1 Power Supply

Table 2-2. Power Supply

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/ Comment
Input Voltage	V_{PP}	0	55	57	V	Supports full IEEE 802.3af/at functionality

.....continued

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/ Comment
Power Supply Current at Operating Mode			1	3	mA	$V_{PP} = 55\text{ V}$

2.2.2 Detection Mode

Table 2-3. Detection Mode

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/Comment
Detection is connected. At this voltage range R_{DET} must be on.	DET_{RANGE}	1.3		10.1	V	Measured between V_{PP} and VPN_{IN}
Detection Switch ON Resistance PD-detection	R_{DET-on}			50	Ω	$2.5\text{ V} \leq (\Delta V_{PP} \text{ to } VPN_{IN}) \leq 10.1\text{ V}$ Measured between R_{DET} and VPN_{IN}
Detection is Disconnected	$R_{DET-off}$	10.1		12.8	V	Measured between V_{PP} and VPN_{IN}
Detection Switch OFF Resistance	$R_{DET-off}$	2.0			M Ω	$12.8\text{ V} \leq (\Delta V_{PP} \text{ to } VPN_{IN}) \leq 57.0\text{ V}$ Measured between R_{DET} and VPN_{IN}
Input Offset Current	I_{OFFSET}			16	μA	1.1 V to 10.1 V $-40\text{ }^{\circ}\text{C} \leq T_J \leq 85\text{ }^{\circ}\text{C}$
	I_{OFFSET}			10	μA	1.1 V to 10.1 V $-40\text{ }^{\circ}\text{C} \leq T_J \leq 55\text{ }^{\circ}\text{C}$

2.2.3 Classification Mode

Table 2-4. Classification Mode

Parameter	Symbol	Min	Typ	Max	Units	Test Condition/ Comment
Classification Current Source, Turn ON Threshold Range Measured at V_{PP}	$V_{THlow-on}$	11.4		13.7	V	Turn on for any I_{CLASS} while V_{PP} increases
Classification Current Source, Turn OFF ThresholdRangeMeasured at V_{PP}	$V_{THhigh-off}$	20.9		23.9	V	Turn off while V_{PP} increases
Current Limit Threshold	$I_{CLASSLIM}$	50.0	68	80.0	mA	
Input Current I_{PP} When Classification Function is Disabled	$I_{CLASSDIS}$			4.0	mA	Class 0 $R_{CLASS} = \text{Disconnect}$

.....continued

Parameter	Symbol	Min	Typ	Max	Units	Test Condition/ Comment
Input Current I_{PP} When Classification Function is Enabled	$I_{CLASSEN}$	9.0	10.5	12.0	mA	Class 1 $R_{CLASS} = 133 \Omega$ $\pm 1\%$
		17.0	18.5	20.0	mA	Class 2 $R_{CLASS} = 69.8 \Omega$ $\pm 1\%$
		26.0	28.0	30.0	mA	Class 3 $R_{CLASS} = 45.3 \Omega$ $\pm 1\%$
		36.0	40.0	44.0	mA	Class 4 $R_{CLASS} = 30.9 \Omega$ $\pm 1\%$

2.2.4 Mark

Table 2-5. Mark

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/ Comment
Mark, Working Voltage Range	V_{MARK}	4.9		10.1	V	When voltage decreases Measured between V_{PP} to VPN_{IN}
Mark Current	I_{MARK}	0.25		4	mA	Chip current

2.2.5 Isolation Switch

Table 2-6. Isolation Switch

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/ Comment
Isolation Switch MOSFET Switches from Off to $I_{LIM-LOW}$	$V_{SW-START}$	36		42	V	
Isolation Switch MOSFET Switched Off	V_{SW-OFF}	30.5		34.5	V	
Startup Current Limit, I_{LIM}	$I_{LIM-LOW}$	105	240	325	mA	
VPN_{IN} to VPN_{OUT} Threshold Voltage for $I_{LIM-LOW}$ to $I_{LIM-HIGH}$ Switchover	V_{DIFF}			0.7	V	When VPN_{IN} to $VPN_{OUT} \leq V_{DIFF}$, Isolating switch switches over from $I_{LIM-LOW}$ to $I_{LIM-HIGH}$.
Over Current Protection Current Limit	OCP	1500	1800	2000	mA	

PD70100/PD70200

Electrical Specifications

.....continued

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/ Comment
Continuous Operation Load Current (PD70100)	I_{LOAD}		350	450	mA	Isolating switch at $I_{LIM-HIGH}$
Continuous Operation Load Current (PD70200)			600	1123		
Continuous Operation Total RDS_{ON}	$SW-RDS_{ON}$			0.6	Ω	Total resistance between VPN_{IN} and VPN_{OUT} Isolating switch at $I_{LIM-HIGH}$

2.2.6 DC/DC Capacitor Discharger

Table 2-7. DC/DC Capacitor Discharger

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/ Comment
DC/DC Input Capacitance			220		μF	For reference only Guaranteed by design (not tested in production)
Discharge Current		22.8	32	50	mA	$7.0 V \leq V_{PP}$ to $VPN_{OUT} \leq 30 V$
Full Discharge Time for Full Discharge of Input Capacitance	T_{DSC}			500	ms	$V_{PP} < UVLO$ threshold Guaranteed by design (not tested in production)

2.2.7 AT_FLAG

Table 2-8. AT_FLAG

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/ Comment
Output Low Voltage				0.4	V	$I_{OL} = 0.75 mA$
				2.5	V	$I_{OL} MAX = 5 mA$
Leakage Current				1.7	μA	$V_{ATFLAG} = 57 V$

2.2.8 PGOOD

Table 2-9. PGOOD

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/Comment
Output Low Voltage				0.4	μF	$I_{OL} = 0.75 mA$
				2.5	mA	$I_{OL} MAX = 5 mA$
Leakage Current				1.7	μA	$V_{PGOOD} = 57 V$

2.2.9 Thermal Shutdown

Table 2-10. Thermal Shutdown

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/ Comment
Thermal Shutdown Temperature		180	200	220	°C	

2.2.10 VAUX

Reference to VPN_{OUT} .

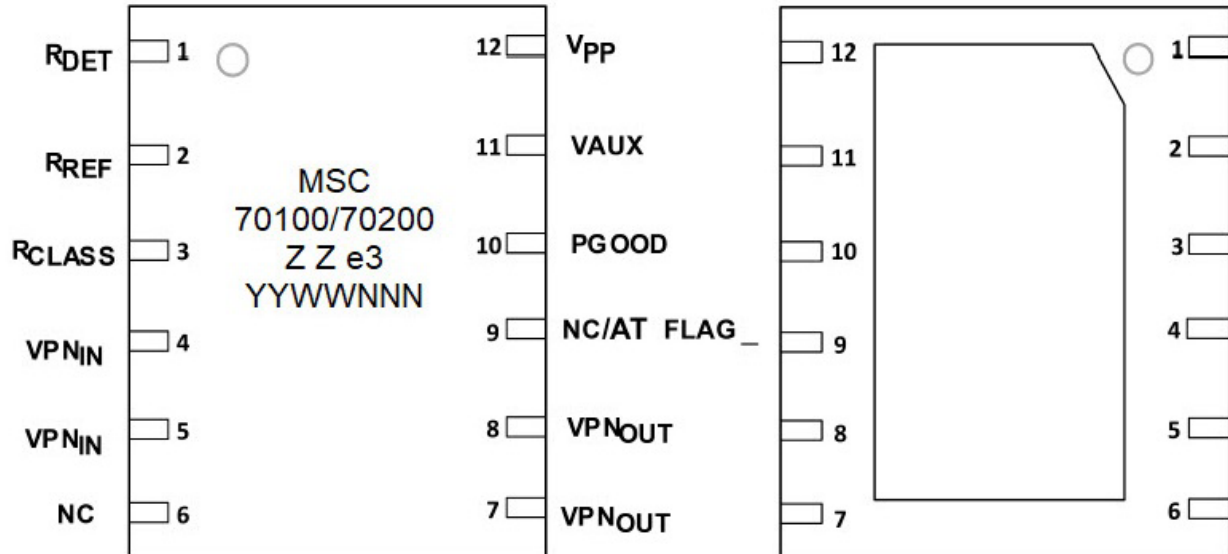
Table 2-11. VAUX

Parameter	Symbol	Min	Typ	Max	Units	Test Conditions/Comment
V_{AUX} Output Voltage On	V_{AUX-on}	9.5	10.5	11.8	V	Isolating switch at $I_{LIM-HIGH}$ and $PGOOD = Low$
Output Current Peak	I_{VAUXP}	0		10	mA	Capacitor = 30 μF When $T_{LOAD} \leq 5$ mS Isolating switch at $I_{LIM-HIGH}$ and $PGOOD = Low$
Output Continuous Current	I_{VAUXC}	0		2	mA	When $T_{LOAD} \leq 10$ mS Isolating switch at $I_{LIM-HIGH}$ and $PGOOD = Low$
V_{AUX} Output Current Limit	I_{VAUX}	10		32	mA	Isolating switch at $I_{LIM-HIGH}$ and $PGOOD = Low$

3. Pin Description

The following illustration shows the device pinout, from the top view and bottom view.

Figure 3-1. Pinout Top View and Bottom View



The following table lists the pin descriptions for the PD70100/PD70200 devices.

Table 3-1. Pin Descriptions

Pin	Pin Name (PD70100)	Pin Name (PD70200)	Type	Description
1	R _{DET}	R _{DET}		Valid Detection resistor. Connect external 24.9 kΩ detection resistor between R _{DET} and V _{PP} .
2	R _{REF}	R _{REF}		Bias current resistor. Connect a 243 k 1% resistor between this pin and VPN _{IN} .
3	R _{CLASS}	R _{CLASS}		Power classification setting. Connect external class resistor between R _{CLASS} and VPN _{IN} .
4	VPN _{IN}	VPN _{IN}	Power	V _{Port} Negative input. Connected to the isolating SW input. N-channel MOSFET source. The exposed thermal pad should be connected to these pins.
5				
6	N.C.	N.C.		
7	VPN _{OUT}	VPN _{OUT}	Power/Gnd	Vport Negative output. Connected to the isolating SW output. N-channel MOSFET Drain. Primary side Ground. A decent ground plane should be deployed around this pin whenever is possible.
8				

.....continued

Pin	Pin Name (PD70100)	Pin Name (PD70200)	Type	Description
9	N.C.	AT_FLAG	Open drain	The two-event detector should discern between AF and AT classification waveforms and outputs the AT_FLAG (PD70200 only).
10	PGOOD	PGOOD	Open drain	After startup, a PGOOD flag is generated in order to optionally inform the application DC/DC converter that the power rails are ready.
11	V _{AUX}	V _{AUX}	Power	Auxiliary output voltage to VPN _{OUT} . Can be used for DC-DC startup for bootstrap initiation.
12	V _{PP}	V _{PP}	Power	High voltage positive input, reference to VPN _{IN} and high voltage positive input, reference to VPN _{OUT} during capacitor discharge.
EP	EPAD	EPAD		Connect to VPN _{IN} . EPAD should be connected to a large copper area for improved thermal management.

4. Package Specifications

This section provides information about the available package.

Note: Dimensions do not include mold flash or protrusions; these shall not exceed 0.155 mm (.006") on any side. Lead dimension shall not include solder coverage. Dimensions are in millimeters, inches for reference only.

Figure 4-1. Package Drawing Dimensions and Measurements

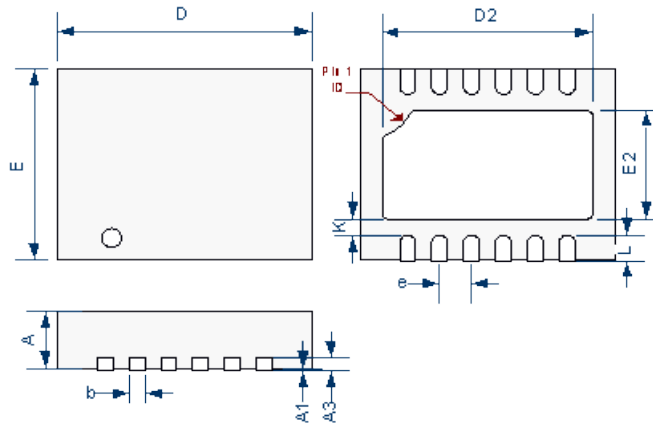


Table 4-1. Package Dimensions: DFN

Dimension	Millimeters		Inches	
	Min	Max	Min	Max
A	0.80	1.00	0.031	0.039
A1	0.00	0.05	0.000	0.002
A3	0.20 REF		0.008 REF	
D	4.00 BSC		0.157 BSC	
E	3.00 BSC		0.118 BSC	
D2	3.00	3.70	0.118	0.146
E2	1.40	1.80	0.055	0.071
e	0.50 BSC		0.0197 BSC	
K	0.20 MIN		0.008 MIN	
L	0.30	0.50	0.012	0.020
b	0.18	0.30	0.007	0.012

4.1 Thermal Specifications

The following table lists the thermal specifications for the PD70100 and PD70200 devices.

Table 4-2. Thermal Specifications

Parameter	Value
Typical thermal resistance: junction to ambient	40 °C/W
Typical thermal resistance: junction to case	4 °C/W

The θ_{JA} numbers are guidelines for the thermal performance of the device/pc-board system. All specifications assume no ambient airflow.

5. Ordering Information

Table 5-1. Ordering Information

Part Number	Packaging Type	Package	Part Marking
PD70100ILD-TR	Tape and Reel	DFN 4 mm × 3 mm 12 pins RoHS Compliant/Pb-free	MSC 70100 Z Z e3 ¹ YYWWNNN ²
PD70200ILD-TR	Tape and Reel	DFN 4 mm × 3 mm 12 pins RoHS Compliant/Pb-free	MSC 70200 Z Z e3 ¹ YYWWNNN ²

1. ZZ e3: ZZ = Random Character with no meaning, and e3 = 2nd level interconnect.
2. YY = Year, WW = Week, NNN = Trace Code.

6. References

- *AN3551 PD70101 and PD70201 PD Device Layout Guidelines*
- *AN3471 Designing a Type 1/2 802.3 or HDBaseT Type 3 Powered Device Using PD702x1 and PD701x1 ICs*
- *AN3472 Implementing Auxiliary Power in PoE*

7. Revision History

Revision	Date	Description
A	11/2020	- Updated to Microchip template. - Updated document number from PD-000303241 to DS00003639. - Added Microchip Powered Device Products Offerings table. - Updated Figure 1. - Added References section.
4.0	08/2019	- The package marking details were updated in the ordering information table. - Figure 1 and Figure 4 were updated.
3.0	01/2018	- The formatting of this document was updated to the latest template. - MSL level was updated. - Part marking was updated. - Absolute Maximum Ratings were updated.
2.0	10/2015	The IC part number was updated from PD70100A to PD70100 (PDN 152044).
1.1	10/2014	The description of Pin 2 was updated.
1.0	03/2012	- The document address footer was updated. - Characteristics were updated.
0.6	07/2011	The specification was updated.
0.5	01/2011	Package was updated.
0.4	12/2010	Package was updated.
0.3	11/2010	- Classification Pulse diagrams were added. - Catalog numbers metrology was changed. - Extensive changes were made to document format and Theory of Operation section. - Package drawing was corrected. - Product Highlight and Typical Characteristics were added.
0.1	04/2010	Initial Revision

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